



THIN FILM SURFACE MOUNT

Bandpass Filter

ABF-26G+

Mini-Circuits

50Ω

24.25 to 27.5 GHz

KEY FEATURES

- Low Mid band Insertion Loss of 1.8 dB Typ.
- High Rejection of 60 dB Typ.
- Good Return Loss of 15 dB Typ.
- Small Size, 3.05 x 11.43 x 2.54 mm

APPLICATIONS

- n258
- 5G Telecommunication

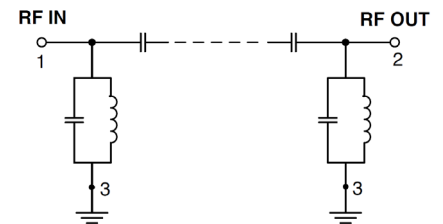


Generic photo used for illustration purposes only

PRODUCT OVERVIEW

Mini-Circuits' Surface Mount Thin-Film filters offer low insertion loss and high rejection realized via Thin-Film on Alumina substrate, using a sputtering process that can guarantee an enhanced Q and repeatable performance. Low pass, high pass, and bandpass surface mount thin-film designs can be realized with this technology up to 40GHz in a small form factor helping customers achieve their SWaP objectives. Using our high quality thin-film manufacturing process we can guarantee repeatability on large batches of filters.

FUNCTIONAL DIAGRAM



ELECTRICAL SPECIFICATIONS^{1,2,3} AT +25°C

Parameter	F#	Frequency (GHz)	Min.	Typ.	Max.	Units
Passband	Center Frequency ⁴	Fc	—	1.8	3.0	
	Insertion Loss	F1-F2	—	3.5	—	dB
	Return Loss	F1-F2	24.25 - 27.5	—	15	—
Stopband, Lower	Rejection	DC-F3	DC - 20	30	45	—
		F3-F4	20 - 22.5	25	45	—
Stopband ,Upper	Rejection	F5-F6	29.25 - 31	25	45	—
		F6-F7	31 - 35	40	60	—
		F7-F8	35 - 40	—	40	—

1. Tested on Evaluation Board P/N TB-ABF-26G+.

2. This filter is bi-directional RF1 and RF2 ports may be interchanged, see S-Parameters for actual performance.

3. This component is not intended for use as a DC-blocking circuit element. In applications where DC voltage and/or current is present at either the input or output ports, external DC blocking capacitors are required.

4. Typical variation ±3%.

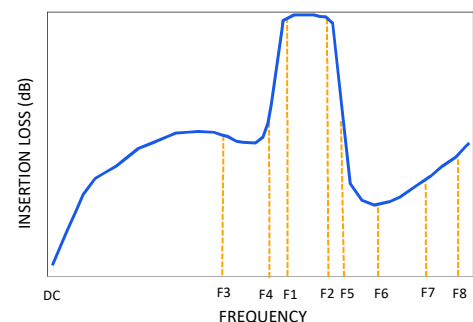
ABSOLUTE MAXIMUM RATINGS⁵

Parameter	Ratings
Operating Temperature	-55 °C to +125 °C
Storage Temperature	-55 °C to +125 °C
Input Power ⁶	1W Max. at 25°C

5. Permanent damage may occur if any of these limits are exceeded.

6. Power rating applies only to signals within the passband.

TYPICAL FREQUENCY RESPONSE AT +25°C





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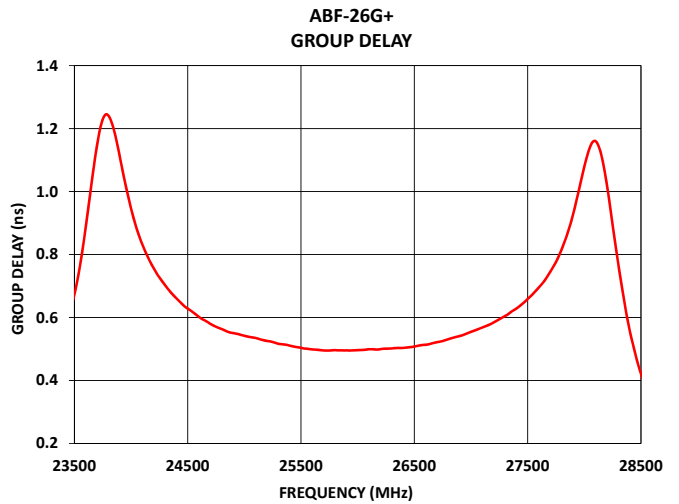
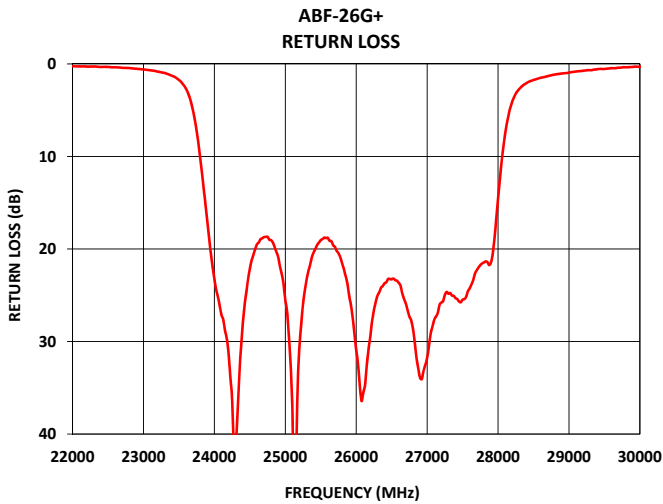
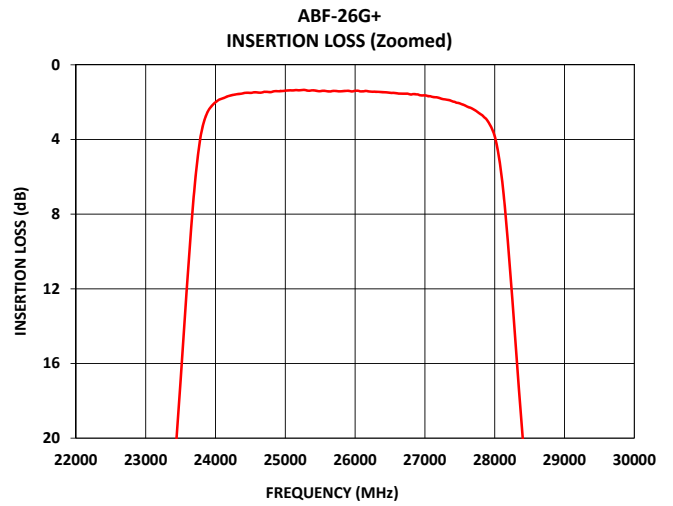
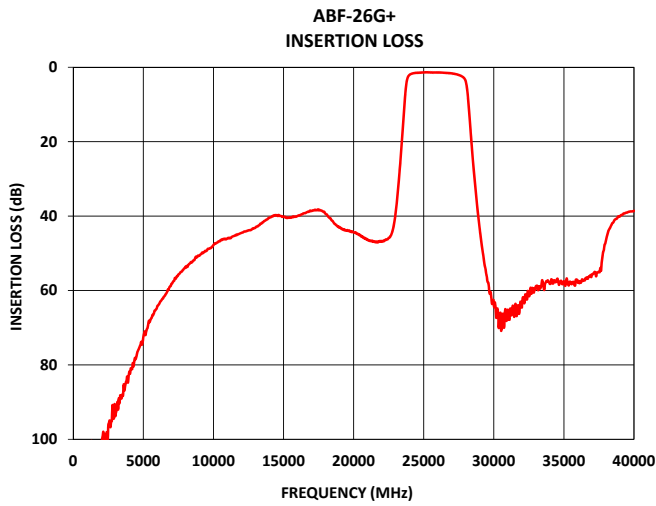
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TYPICAL PERFORMANCE GRAPHS AT +25°C





FUNCTIONAL DIAGRAM

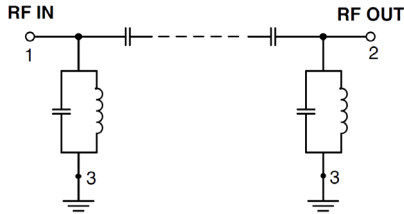


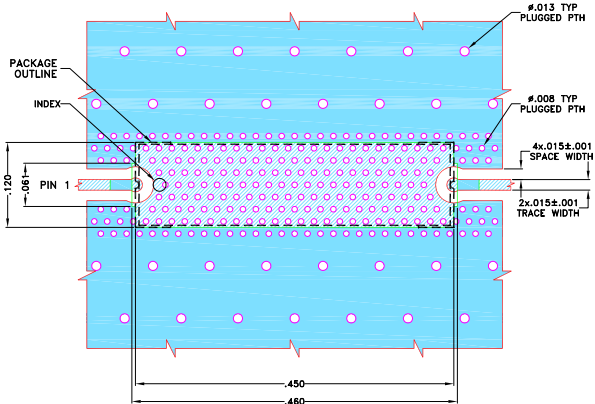
Figure 1. ABF-26G+ Functional Diagram

PAD DESCRIPTION

Function	Pad Number	Description
RF1 ²	1	Connects to RF Input Port
RF2 ²	2	Connects to RF Output Port
GROUND	3	Connects to Ground on PCB, (See drawing PL-713)
NC	—	No connection, not used internally. See drawing PL-713 for connection to PCB

SUGGESTED PCB LAYOUT (PL-713)

SUGGESTED MOUNTING CONFIGURATION FOR VG3044 CASE STYLE

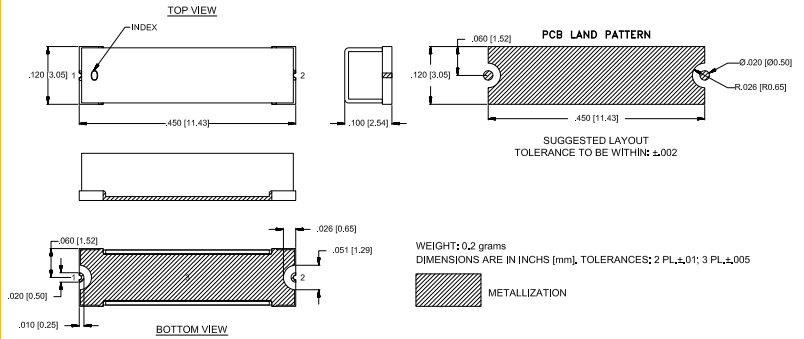


NOTES:

1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS (R04350B) WITH DIELECTRIC THICKNESS .0066±.0007. COPPER: 1/2 Oz. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
 - DENOTES PCB COPPER PATTERN WITH SMOBC (SOLDER MASK OVER BARE COPPER)
 - DENOTES PCB COPPER PATTERN FREE OF SOLDERMASK

Figure 2. Suggested PCB Layout PL-713

CASE STYLE DRAWING



WEIGHT: 0.2 grams
DIMENSIONS ARE IN INCHS [mm]. TOLERANCES: 2 PL_±.01; 3 PL_±.005

■ METALLIZATION

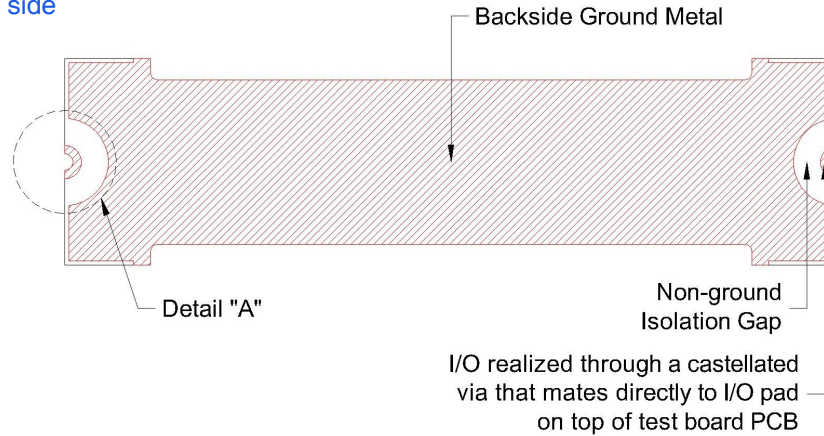
PRODUCT MARKING*: ABF-26G

*Marking may contain other features or characters for internal lot control.

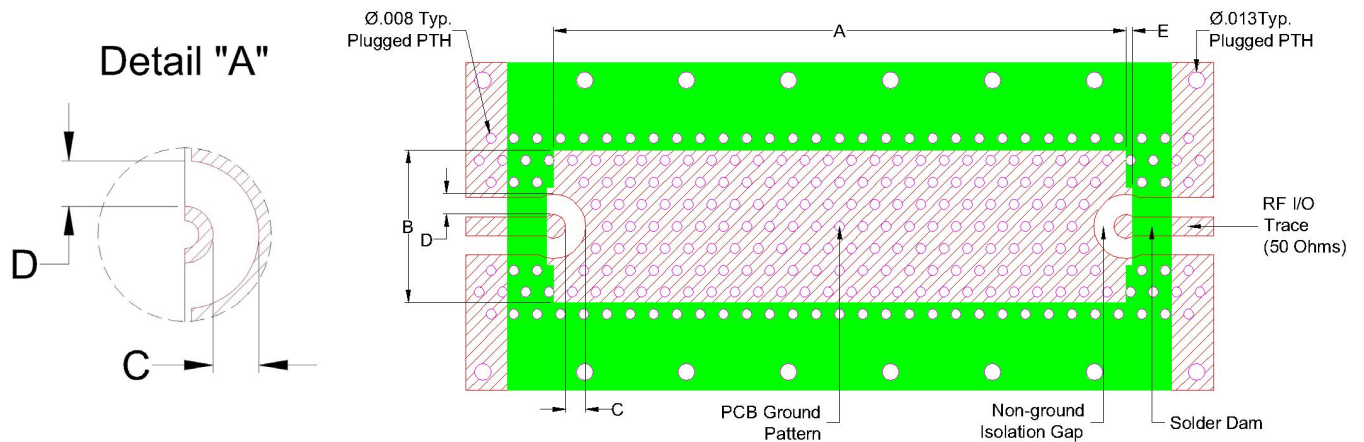


RECOMMENDED PCB LAYOUT PATTERN FOR FILTER

Filter Back side



PCB Pattern Recommendations



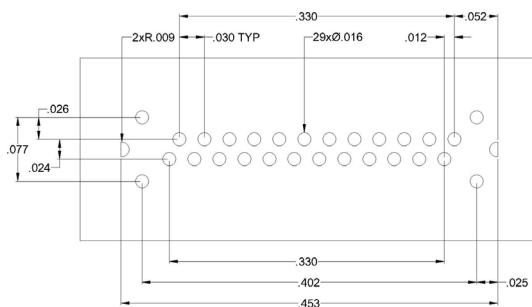
- 1) Customer PCB's ground pattern length (dimension A) can be similar to filter length.
- 2) Customer PCB's ground pattern width (dimension B) can be similar to filter width.
- 3) Dimensions C and D on Filter RF I/O detail and Customer PCB pattern can be closely match. The dimensions of C and D on the Customer PCB pattern can be slightly larger to account for component alignment tolerance (ground metal can be pulled back from RF I/O trace).
- 4) Recommend to use solder mask at Customer PCB at outer area of filter pattern/footprint without any clearance.
- 5) Recommended to use Solder mask at I/O of Customer PCB with 5 mil clearance from filter I/O edge (dimension E)



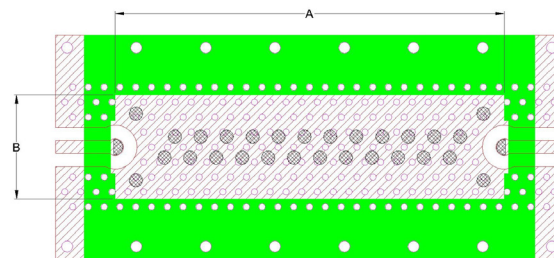
COMMENTS ON COMPONENT HANDLING AND SOLDER ATTACH

- 1) Avoid using soldering iron directly to the ceramic filter. This would lead to development of crack in the component due to thermal shock.
- 2) Vacuum pick-up tool or plastic tweezers are recommended for handling the components. Extra care should be taken not to scratch the filter or metal area.
- 3) Use 2-3 mil thickness stencil plate and screen print the solder. Refer below picture for recommended stencil pattern to get the best solder attachment.

Stencil opening drawing



Solder location after screen print



- 4) Plugged ground vias in the PWB will improve attachment consistency.
- 5) Recommended to have a similar or closer test board material and thickness (refer Mini-Circuits evaluation board for details) to minimize the CTE over the temperature range.



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ADDITIONAL DETAILED INFORMATION IS AVAILABLE ON OUR DASH BOARD.

[CLICK HERE](#)

Performance Data and Graphs	Data
	Graphs
	S-Parameter (S2P Files) Data Set (.zip file) De-embedded to device pads
Case Style	VG3044 Lead Finish: Gold over Nickel Plate
RoHS Status	Compliant
Tape and Reel	TR-F004
Suggested Layout for PCB Design	PL-713
Evaluation Board	TB-ABF-26G+
	Gerber File
Environmental Rating	ENV120

NOTES

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits' standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html



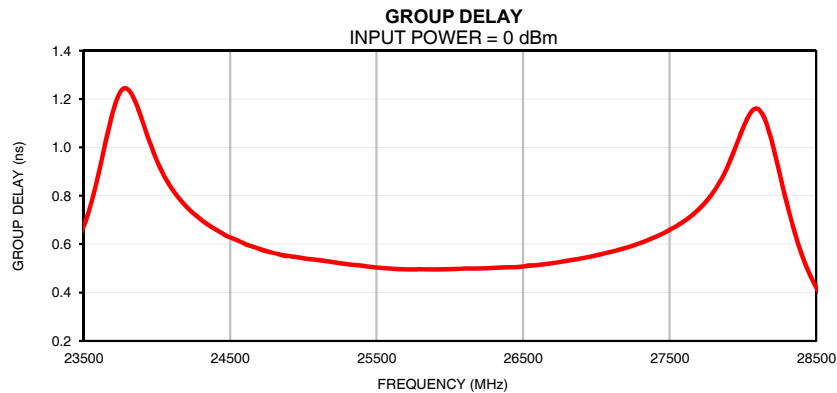
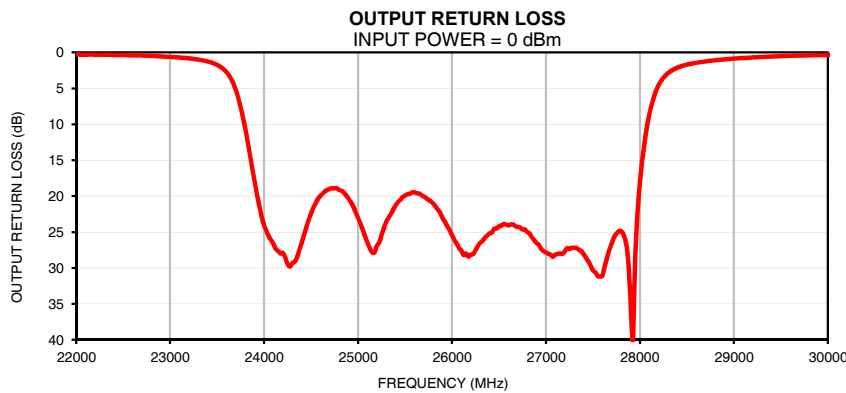
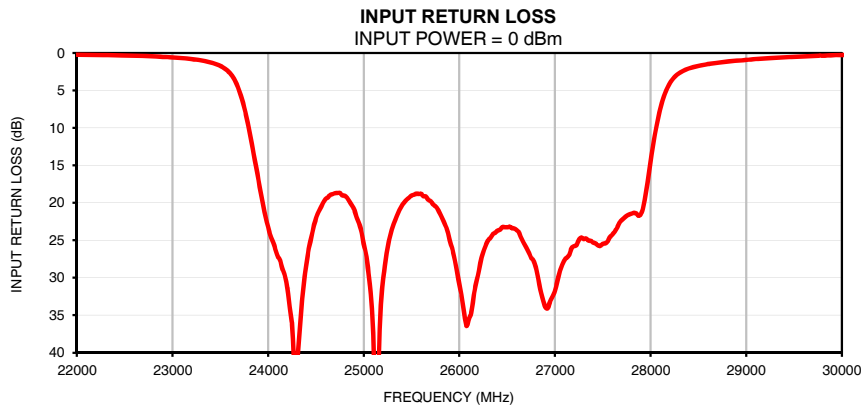
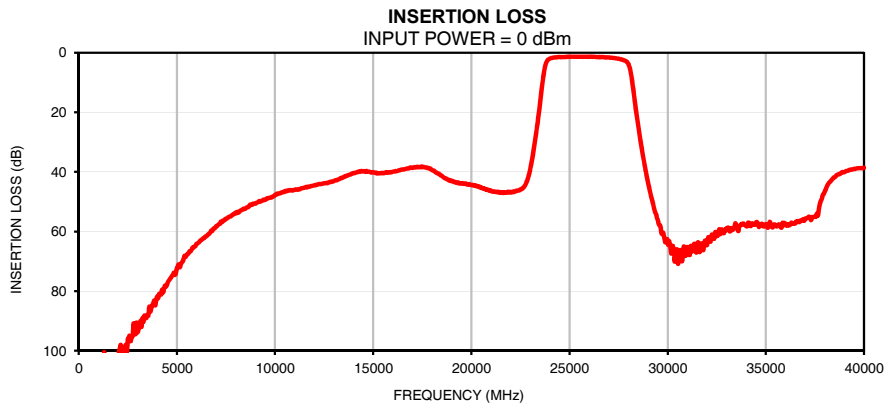
Thin-Film Bandpass Filter

ABF-26G+

Typical Performance Data

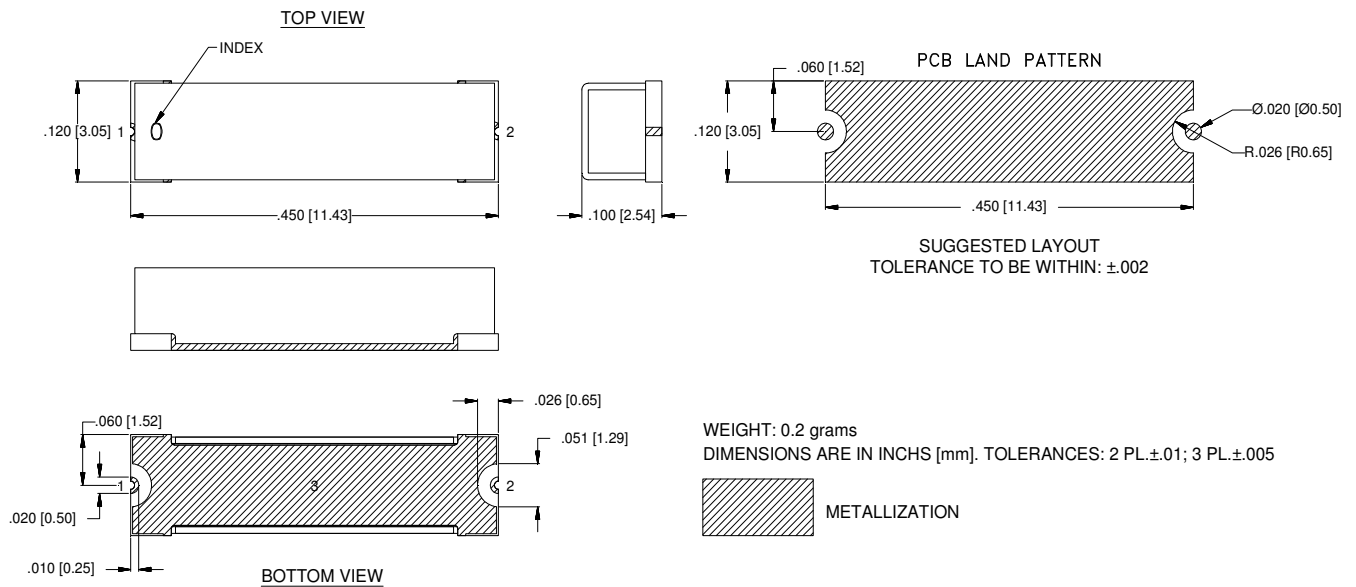
FREQ.	Insertion Loss	Input Return Loss	Output Return Loss	FREQ.	Group Delay
(MHz)	(dB)	(dB)	(dB)	(MHz)	(ns)
10	114.71	0.03	0.03	24250	0.73
50	114.25	0.07	0.08	24300	0.70
100	111.74	0.12	0.11	24350	0.68
500	120.14	0.19	0.20	24400	0.66
1000	105.71	0.21	0.22	24450	0.64
2000	107.46	0.13	0.20	24500	0.63
3000	93.70	0.02	0.02	24550	0.62
4000	81.81	0.06	0.04	24600	0.60
5000	72.46	0.05	0.06	24650	0.59
6000	64.18	0.01	0.04	24700	0.58
7000	58.24	0.00	0.07	24750	0.57
8000	53.65	0.04	0.00	24800	0.56
9000	50.65	0.01	0.00	24850	0.56
10000	47.76	0.06	0.08	24900	0.55
11000	46.01	0.12	0.11	24950	0.55
12000	44.52	0.12	0.10	25000	0.54
13000	43.09	0.08	0.08	25050	0.54
14000	40.45	0.12	0.13	25100	0.53
15000	40.16	0.16	0.15	25150	0.53
18000	39.41	0.23	0.26	25200	0.53
20000	44.38	0.23	0.26	25250	0.52
20400	44.98	0.25	0.25	25300	0.52
20800	45.88	0.23	0.25	25350	0.51
21200	46.64	0.23	0.26	25400	0.51
21600	46.93	0.23	0.28	25450	0.51
22000	46.73	0.24	0.28	25500	0.50
22500	45.94	0.32	0.37	25550	0.50
23200	31.51	0.82	0.82	25600	0.50
23425	20.88	1.35	1.36	25650	0.50
23625	10.05	3.07	3.15	25700	0.50
23825	3.17	11.78	12.36	25750	0.50
24250	1.61	36.24	29.45	25800	0.50
24800	1.46	19.04	19.13	25875	0.50
25200	1.37	30.50	26.93	25900	0.50
25875	1.40	23.68	22.33	25950	0.50
26000	1.39	30.94	25.38	26000	0.50
26400	1.47	23.70	25.20	26050	0.50
27000	1.63	31.78	27.84	26100	0.50
27500	2.07	25.48	30.34	26150	0.50
27900	3.01	21.48	34.66	26200	0.50
28000	3.82	14.56	18.15	26250	0.50
28200	10.00	4.07	4.51	26300	0.50
28400	19.95	2.08	2.13	26350	0.50
28625	30.01	1.46	1.38	26400	0.50
29000	43.67	0.94	0.85	26450	0.51
29250	50.51	0.68	0.67	26500	0.51
30200	66.85	0.22	0.29	26550	0.51
30800	65.65	0.07	0.21	26600	0.51
31000	65.18	0.05	0.21	26650	0.52
31600	66.03	0.05	0.24	26700	0.52
32000	64.56	0.07	0.28	26750	0.53
32400	61.13	0.14	0.32	26800	0.53
33000	58.89	0.25	0.43	26850	0.54
33400	58.41	0.36	0.46	26900	0.54
35000	57.52	0.50	0.51	26950	0.55
36000	57.91	0.48	0.62	27000	0.55
37000	55.68	1.08	1.62	27050	0.56
38000	46.51	2.75	2.32	27100	0.57
39000	40.06	0.92	0.83	27300	0.60
40000	38.60	0.74	0.75	27500	0.66

Typical Performance Curves



Outline Dimensions

VG3044



Notes:

1. Case material: Gold over Nickel over Annealed Stainless Steel.
2. Base: Ceramic
3. Termination finish: **as shown below or indicated on Data Sheet.**
For RoHS Case Styles: Gold over Nickel plate. All models, (+) suffix.



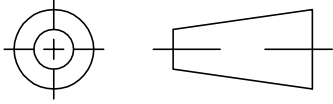
P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS

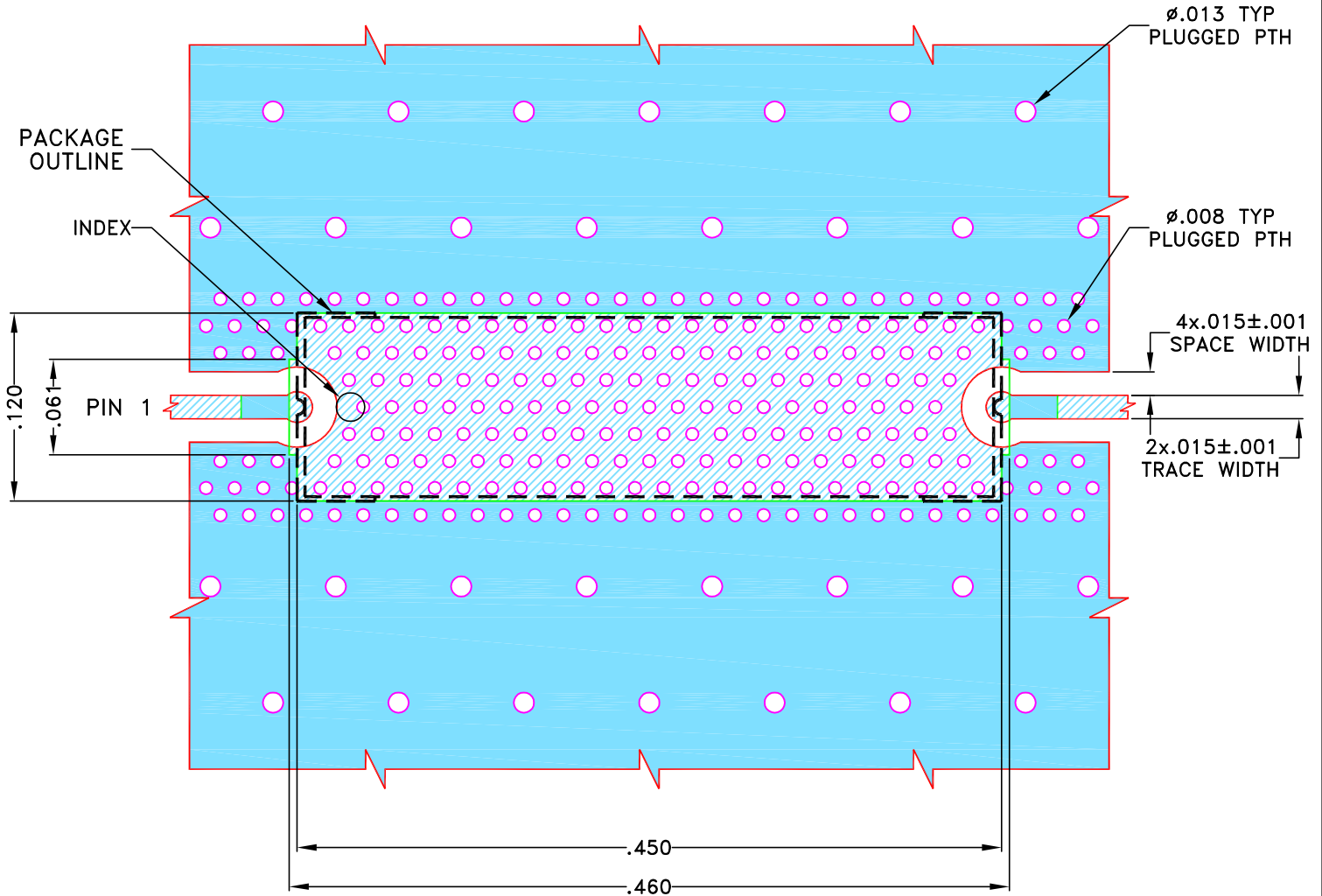
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	NPO-001850	NEW RELEASE	JUL 21	DDR	VC

SUGGESTED MOUNTING CONFIGURATION FOR VG3044 CASE STYLE



NOTES:

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- BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER PATTERN WITH SMOBC (SOLDER MASK OVER BARE COPPER)
 DENOTES PCB COPPER PATTERN FREE OF SOLDERMASK

UNLESS OTHERWISE SPECIFIED	INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN: DDR	06 JUL 21
TOLERANCES ON:	CHECKED: RR	06 JUL 21
2 PL DECIMALS ±	APPROVED: NN	06 JUL 21
3 PL DECIMALS ± .005		
ANGLES ±		
FRACTIONS ±		

Mini-Circuits® 13 Neptune Avenue
Brooklyn NY 11235

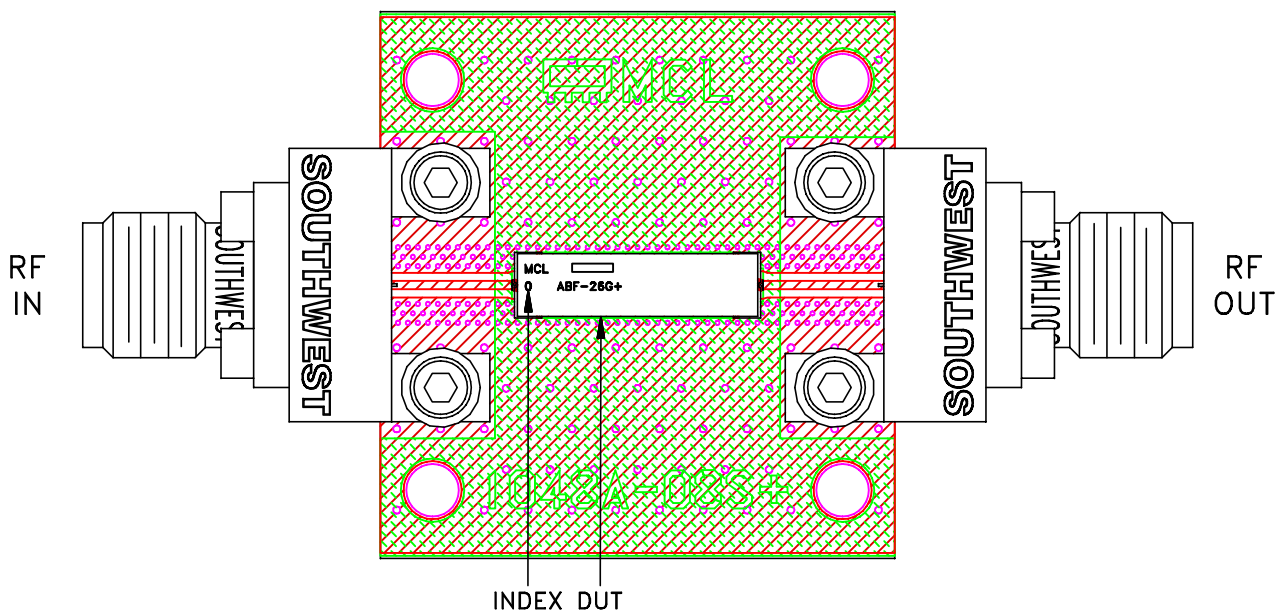
PL DWG, VG3044 C.S, 50 OHM, ABF

SIZE: A	CODE IDENT: 15542	DRAWING NO: 98-PL-713	REV: OR
FILE: 98-PL-713	SCALE: 9:1	SHEET: 1 OF 1	

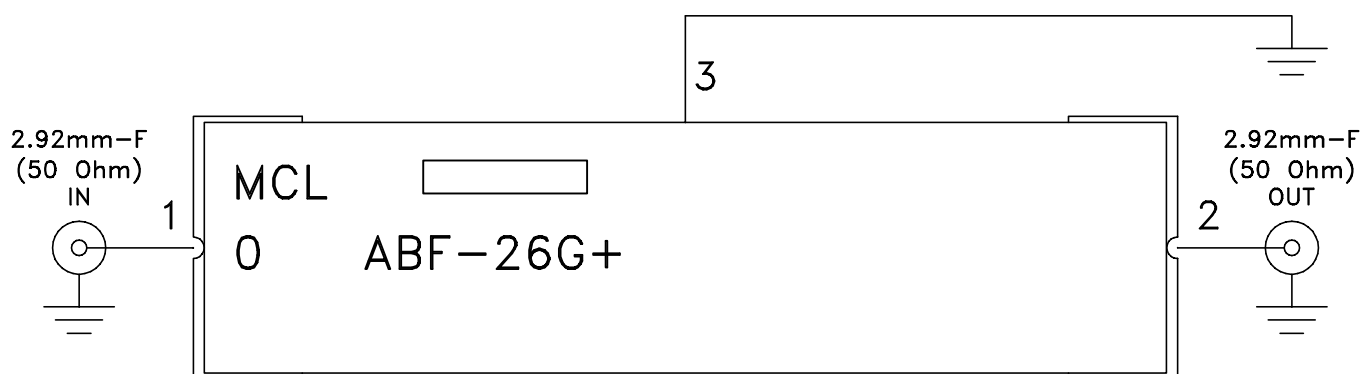
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Evaluation Board and Circuit

TB-ABF-26G+




Schematic diagram



Notes:

1. PCB Material: ROGERS (R04350B) OR Equivalent, Dielectric Constant=3.48±.05
Dielectric Thickness: .0066" ± .0007"
2. 50 Ohm 2.92mm Female Connectors.

 **Mini-Circuits®**

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Thermal Shock	-55° to 125°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, Except +125°C